# LAPPROVAL SHEETI

# (WI-FI)



Nice Korea Components Co., Ltd

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# **LAPPROVAL SHEET**

Product	NKCBTF-F02	
Model	SPP-R200II	
Designed by	Checked by	Approved by

2013. 9.14

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# 1. Revision History

Rev. Issue			SPP-R200II	
1104.13340	Page	Designed	Date	
Appro. Issue	_	KC. NAM	2013.9.14	
	Appro. Issue	Appro. Issue –	Appro. Issue – KC. NAM	

## 2. Features & Applications

#### 2.1 Features

This ceramic chip antenna is applied to 2.4 GHz ISM band applications, i.e. Bluetooth. Zigbee, Wireless LAN, etc...

형태	Bulk Ceramic		
	유전체	Al2O3(Alumina)	
재질	전극	은(Ag)	
크기 (mm)	L = 10 + / - 0.1 $W = 2 + / - 0.1$ $T = 1.2 + / - 0.1$	T T	
Weight	97~100 mg		

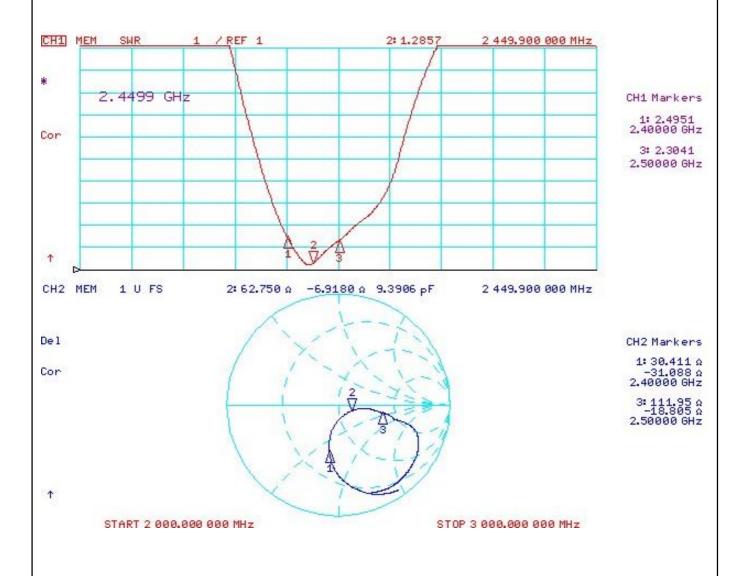
## 3. Electrical Specifications

3-1.

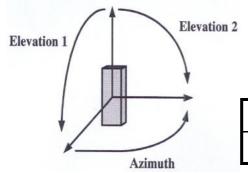
- \* All item are measured in room temperature (24 $\sim$ 26 °C).
- \* All item are measured at customer set condition.

No.	Items	Typical Data
1	Frequency (MHz)	2400 ~2500
2	VSWR	3:1
3	Total Gain (Peak/AVG.) [dBi]	3.91 / -3.53
4	Impedance	50 ohm
5	Polarization	Linear

### 3-2. VSWR (S11) of USER SET condition

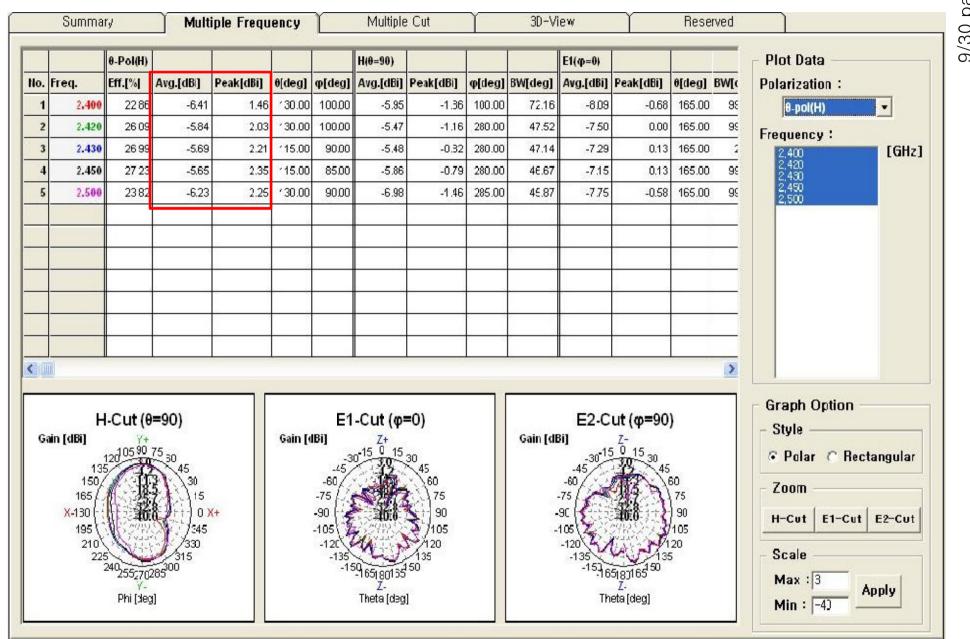


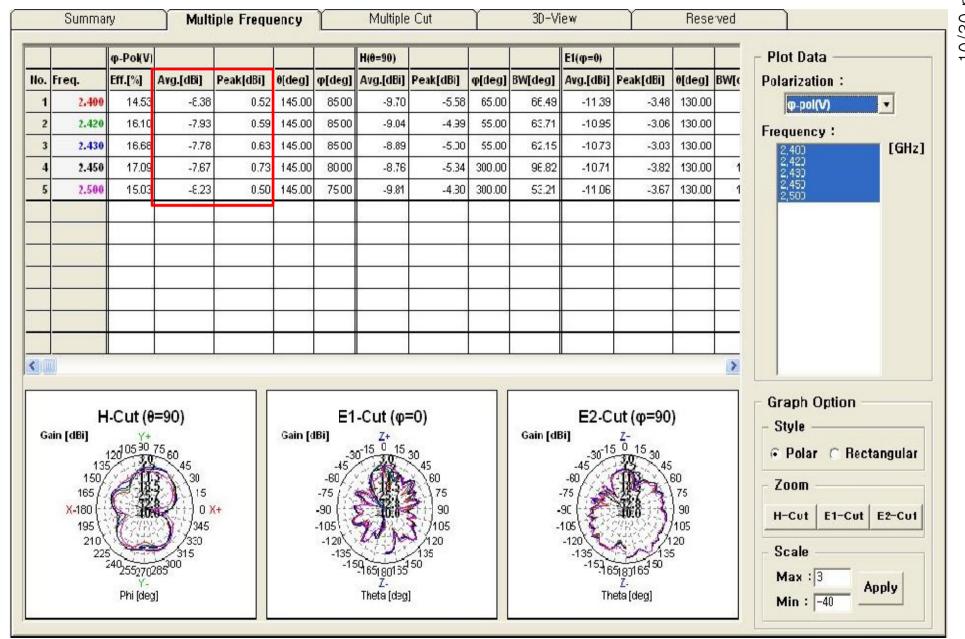
### 3-3. Radiation Patterns

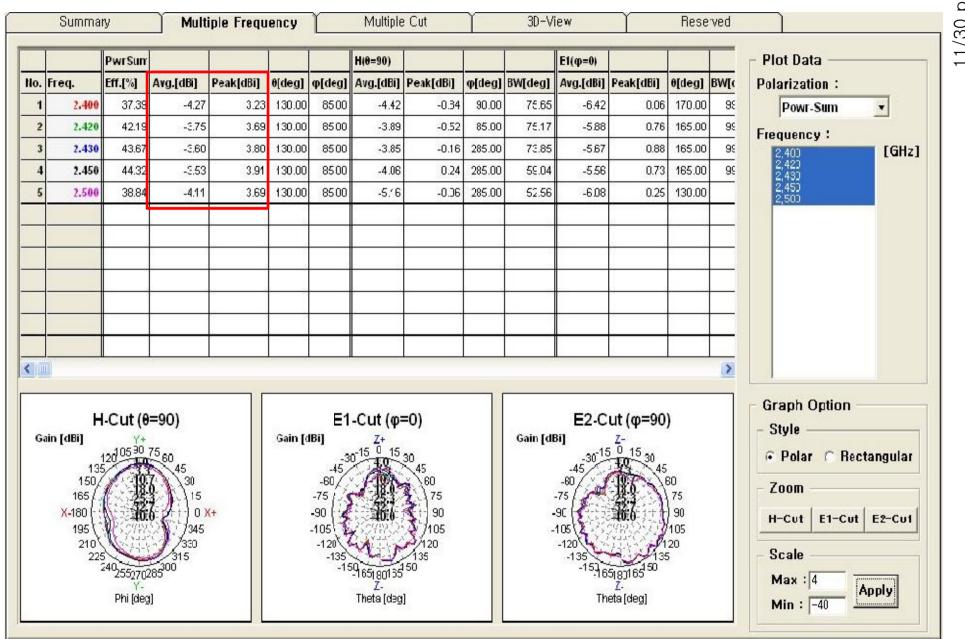


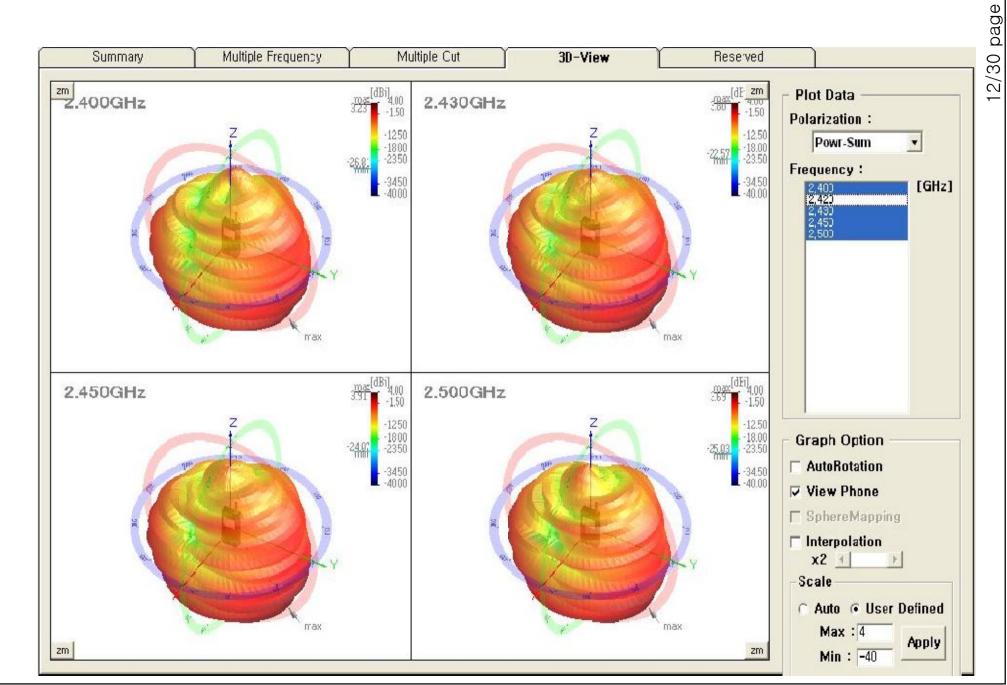
	Vertical Field of measured plane
Phi	Horizontal Field of measured plane

Gain(dBi)	Total Gain (Peak/Avg) [dBi]		3.91 / -3.53	
	Azimuth		Peak	2.35
		H-pole	Avg	-5.65
	Elevation	\/	Peak 0	0.73
		V-pole	Avg	-7.67





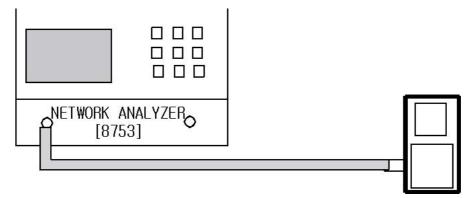




#### 4. Measurements Method & Conditions

The measurement of antenna performance is measurement of gain, radiation pattern using ORBIT/FR apparatus in Anechoic chamber and measurement of VSWR using Network analyzer.

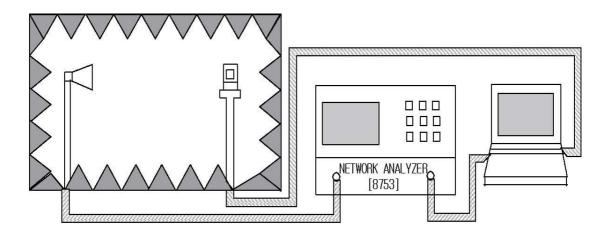
#### 4-1. The measurement of Frequency and VSWR



#### [Measurement Method]

- 1. As seen the above, network analyzer is set up for S11 measurement.
- 2. The measurement frequency range is to set up from 2 GHz to 3 GHz.
- 3. Perform S11 one port full calibration.
- 4. Measure the VSWR of three points of Bluetooth frequency range such as 2.4 GHz, 2.45 GHz, and 2.5 GHz.

#### 4-2. The measurement of Gain & Radiation Patterns

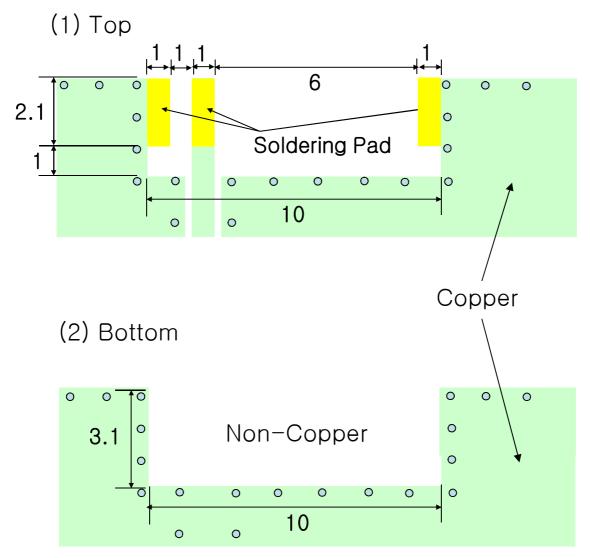


#### [Measurement Method]

- 1. As seen the above, network analyzer is to set up in Anechoic chamber.
- 2. As seen beneath, for the measurement planes as Azimuth, Elevation 1, and Elevation 2, measure Gain data of vertical polarization and horizontal polarization for each plane.

# 5. PCB Layout & Solder Pad size

5-1. Layout

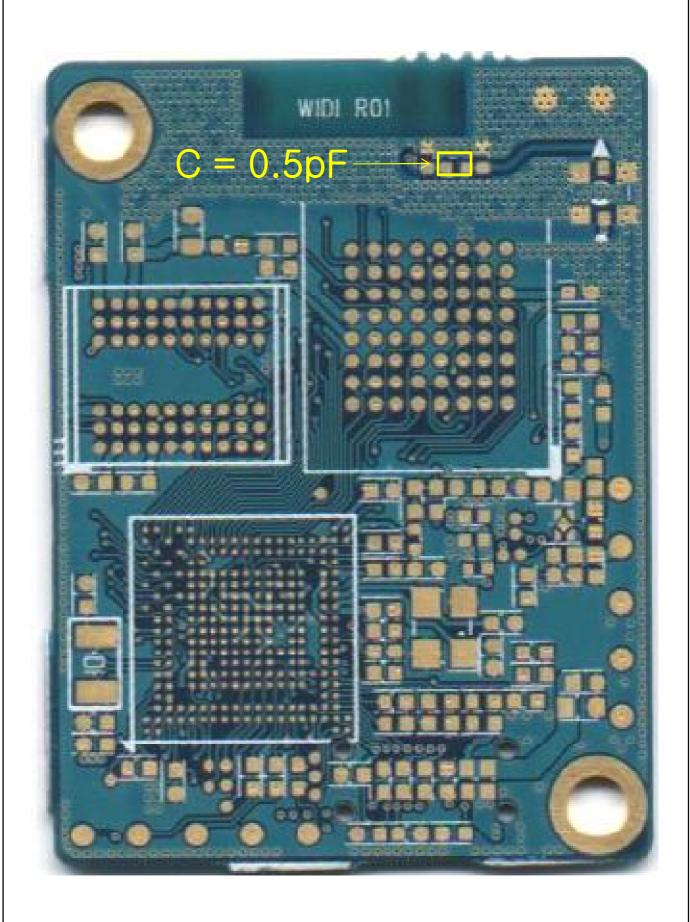


Unit: mm

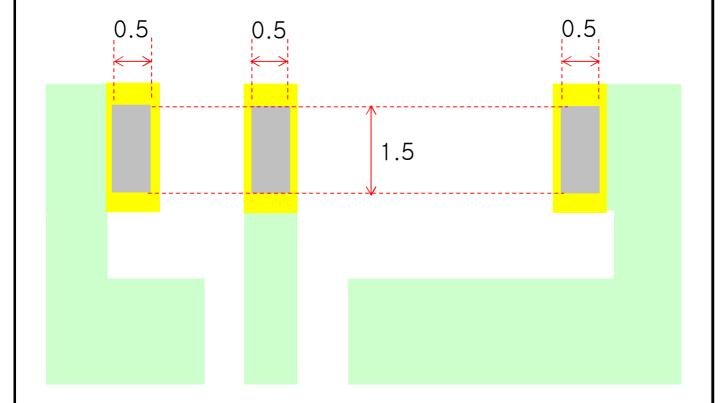
tolerances: +/- 0.05

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### 5-2. Matching Circuits







Unit: mm

Soldering Cream의 면적은 SMD 업체 현황(메탈 스크린 두께, 온도)에 따라 변경 될 수 있으므로 협의를 요함



Solder Pad



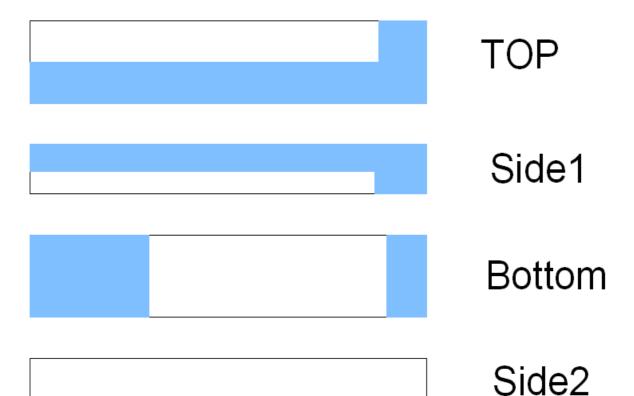
Soldering Cream

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### 5-4. Antenna position



### 6. Ag pattern



## 7. Marking View



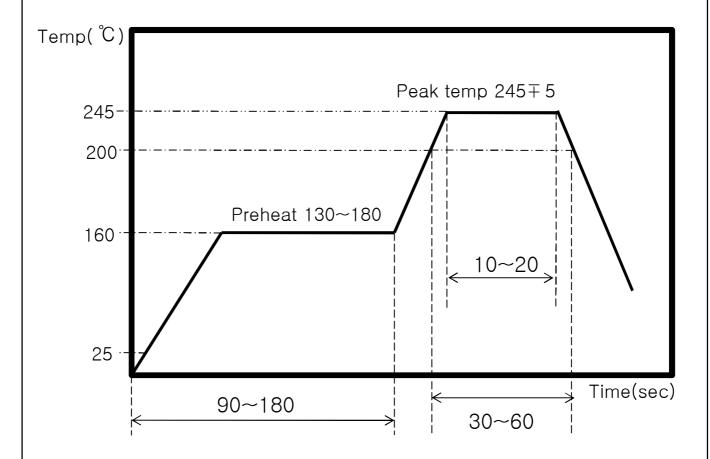
7-1. 마킹 종류

\* RF용 검정 잉크 사용

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### 8. Reflow Profile

8-1. Standard reflow condition(Pb-free)



SMD 업체 현황에 따라 peak temp 및 시간은 변경 될 수 있으므로 협의를 요함

8-2. 수동 납땜 (인두기)을 할 경우(Pb-free)

인두 온도: 340 'C / 시간: 각 단 max 3 sec

# 9. Environmental Tests

No.	ITEM	TEST COND	TEST REQU
1	High Temperature Resistance	<ol> <li>Temp: +125±5℃</li> <li>Time: 1000±24hrs</li> <li>Measure Fc after left for 24hrs min. at room temp</li> </ol>	Within electric spec(VSWR)     No visual damage
2	Low Temperature Resistance	<ol> <li>Temp: -40±5℃</li> <li>Time: 1000±24hrs</li> <li>Measure Fc after left for 48hrs min. at room temp</li> </ol>	<ol> <li>Within electric spec(VSWR)</li> <li>No visual damage</li> </ol>
3	Thermal Shock	<ol> <li>1. 1cycle/step1:-40±3℃,30min step2:+125±3℃,30min</li> <li>2. Number of cycle:30</li> <li>3. Measure after left for 48hrs min. at room temp</li> </ol>	1. Within electric spec(VSWR) 2. No visual damage
4	Humidity	<ol> <li>Humidity:85%RH</li> <li>Temp:+85±3°C</li> <li>Time:1000±24hrs</li> <li>Measure Fc after left for 48hrs min. at room temp</li> </ol>	1. Within electric spec(VSWR) 2. No visual damage
5	Adhesive strength of termination	1. Applied force on SMD chip till detached point from PCB.	1. No mechanical damage by forces applied on the right 2. Strength(F)>5kgf